





Design Rules Verification Report

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Warnings 0 Rule Violations 50

Warnings	
Total	0

Rule Violations	
Clearance Constraint (Gap=0.254mm) (All),(All)	3
Short-Circuit Constraint (Allowed=No) (All),(All)	0
Un-Routed Net Constraint ((All))	0
Modified Polygon (Allow modified: No), (Allow shelved: No)	0
Width Constraint (Min=0.2mm) (Max=0.254mm) (Preferred=0.254mm) (All)	0
Power Plane Connect Rule(Relief Connect)(Expansion=0.508mm) (Conductor	0
World \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	0
Hole To Hole Clearance (Gap=0.254mm) (All),(All)	0
Minimum Solder Mask Sliver (Gap=0.254mm) (All),(All)	47
Silk To Solder Mask (Clearance=0.254mm) (IsPad),(All)	0
Silk to Silk (Clearance=0.254mm) (All),(All)	0
Net Antennae (Tolerance=0mm) (All)	0
Room Sheet1 (Bounding Region = (57.02mm, 53.42mm, 100.92mm, 96.62mm)	
Height Constraint (Min=0mm) (Max=25.4mm) (Prefered=12.7mm) (All)	0
Total	50

Clearance Constraint (Gap=0.254mm) (All),(All)

Clearance Constraint: (0.22mm < 0.254mm) Between Pad C1-1(3.89mm,7.2mm) on Top Layer And Pad Clearance Constraint: (0.22mm < 0.254mm) Between Pad C2-1(3.11mm,9.2mm) on Top Layer And Pac Clearance Constraint: (0.22mm < 0.254mm) Between Pad C3-1(3.89mm,8.2mm) on Top Layer And Pad

Minimum Solder Mask Sliver (Gap=0.254mm) (All),(All) Minimum Solder Mask Sliver Constraint: (0.017mm < 0.254mm) Between Pad C1-1(3.89mm,7.2mm) on Top Layer And Pad Minimum Solder Mask Sliver Constraint: (0.017mm < 0.254mm) Between Pad C2-1(3.11mm,9.2mm) on Top Layer And Pad Minimum Solder Mask Sliver Constraint: (0.017mm < 0.254mm) Between Pad C3-1(3.89mm,8.2mm) on Top Layer And Pad Minimum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-1(8.87mm,9.35mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-1(8.87mm,9.35mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-10(5.57mm,7.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-10(5.57mm,7.05mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-10(5.57mm,7.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-11(5.57mm,6.55mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-11(5.57mm,6.55mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-12(5.57mm,6.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-13(6.37mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-13(6.37mm,5.25mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-14(6.87mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-14(6.87mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-15(7.37mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-15(7.37mm,5.25mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-16(7.87mm,5.25mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-16(7.87mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-17(8.37mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-17(8.37mm,5.25mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-18(8.87mm.5.25mm) on Top Laver And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-19(9.67mm,6.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-19(9.67mm,6.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-2(8.37mm, 9.35mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-2(8.37mm, 9.35mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-20(9.67mm,6.55mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-20(9.67mm.6.55mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-21(9.67mm,7.05mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-21(9.67mm,7.05mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-22(9.67mm, 7.55mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-22(9.67mm, 7.55mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-23(9.67mm,8.05mm) on Top Layer And Madmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-23(9.67mm,8.05mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-24(9.67mm,8.55mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And May mum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.107mm < 0.254mm) Between Pad U1-25(7.62mm,7.3mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-3(7.87mm,9.35mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-4(7.37mm,9.35mm) on Top Layer And Maymum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-5(6.87mm, 9.35mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-7(5.57mm,8.55mm) on Top Layer And Mandmum Solder Mask Sliver Constraint: (0.097mm < 0.254mm) Between Pad U1-8(5.57mm,8.05mm) on Top Layer And Pad

Electrical Rules Check Report

Class	Document	Message
Warning	Sheet1.SchDoc	Component U1 CP2104-F03-GM at 5000mil,5600mil: Component revision is Out of Date.
		is out of date.







